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Attorney Docket: 042390.P6139C

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Carapella et al.

Examiner: Ngo, H.

Serial No.: 09/665,034

Art Group: 2831

Filed: September 19, 2000

For: METHODS FORMING AN
INTEGRATED CIRCUIT
PACKAGE WITH A SPLIT
CAVITY WALL (As Amended)

Assistant Commissioner for Patents
Washington, D.C. 20231

AMENDMENT AND RESPONSE

Dear Sir:

Applicant respectfully responds herein to the Office Action
mailed on October 16, 2001. Please enter the following amendments
and remarks in the above referenced patent application:

IN THE TITLE

Please amend the Title of the Application to:

--METHODS FORMING AN INTEGRATED CIRCUIT PACKAGE WITH A SPLIT CAVITY
WALL--.

IN THE SPECIFICATION

Please amend the specification as follows:

In the section "CROSS REFERENCE TO RELATED APPLICATION"